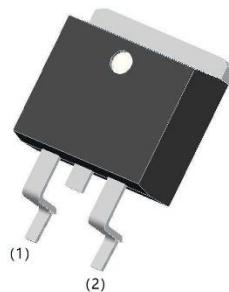


**V<sub>RRM</sub>** = 1200 V

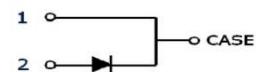
**I<sub>F</sub>(T<sub>c</sub>=155°C)** = 10 A

**Q<sub>C</sub>** = 63 nC



### Features:

- Extremely low reverse current
- No reverse recovery current
- Temperature independent switching
- Positive temperature coefficient on V<sub>F</sub>
- Excellent surge current capability
- Low Capacitive charge



### Benefits

- Essentially No switching losses
- System efficiency improvement over Si Diodes
- Increased power density
- Enabling higher switching frequency
- Reduction of Heat Sink Requirements
- System Cost savings due to smaller magnetics
- Reduced EMI



### Applications

- Switch Mode Power Supplies (SMPS)
- Uninterruptable power supplies
- Motor Drivers
- Power Factor Correction

### Pacakge Pin definitions

- Pin1- Cathode
- Pin2- Anode

### Package Parameters

Part Number	Marking	Package
B1D10120F	B1D10120F	TO-263-2

**Maximum ratings**

Symbol	Parameter	Test conditions	Value	Unit
$V_{RRM}$	Repetitive Peak Reverse Voltage		1200	V
$V_{RSM}$	Surge Peak Reverse Voltage		1200	V
$I_F$	Continuous Forward Current	Tc=25°C Tc=135°C Tc=155°C	30 14.5 10	A
$I_{FSM}$	Non-Repetitive Forward Surge Current	Tc=25°C , $t_p$ =10ms, sine halfwave	77	A
$\int i^2 dt$	$i^2 t$ Value	Tc=25°C , $t_p$ =10ms	29.6	A <sup>2</sup> S
$P_{tot}$	Power Dissipation	Tc=25°C Tc=110°C	134 43	W
$T_j$	Operating junction temperature		-55~175	°C
$T_{stg}$	Storage temperature		-55~135	°C

**Thermal Characteristics**

Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
$R_{th(jc)}$	Thermal resistance from junction to case		0.931		K/W
$R_{th(ja)}$	Thermal resistance from junction to ambient		66.76		K/W

**Electrical Characteristics****Static Characteristics (T<sub>j</sub>=25°C unless otherwise specified)**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Value</b>			<b>Unit</b>
			<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	
V <sub>DC</sub>	DC blocking voltage	T <sub>j</sub> =25°C	1200			V
V <sub>F</sub>	Diode forward voltage	I <sub>F</sub> =10A T <sub>j</sub> =25°C I <sub>F</sub> =10A T <sub>j</sub> =175°C		1.46 2.17		V
I <sub>R</sub>	Reverse current	V <sub>R</sub> =1200V T <sub>j</sub> =25°C V <sub>R</sub> =1200V T <sub>j</sub> =175°C		4.5 45		μA

**Dynamic Characteristics (T<sub>j</sub>=25°C unless otherwise specified)**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Value</b>			<b>Unit</b>
			<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	
Q <sub>C</sub>	Total capacitive charge	V <sub>R</sub> =800V T <sub>j</sub> =25°C $Q_C = \int_0^{V_R} C(V)dV$		63		nC
C	Total Capacitance	V <sub>R</sub> =1V f=1MHz V <sub>R</sub> =400V f=1MHz V <sub>R</sub> =800V f=1MHz		614 62 51		pF

### Typical Performance

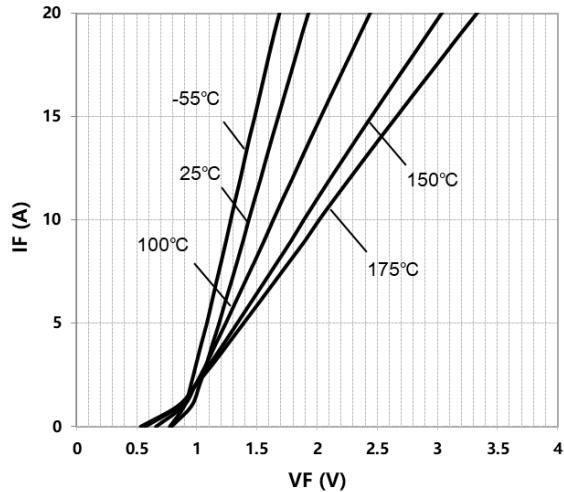


Figure 1. Typical forward characteristics

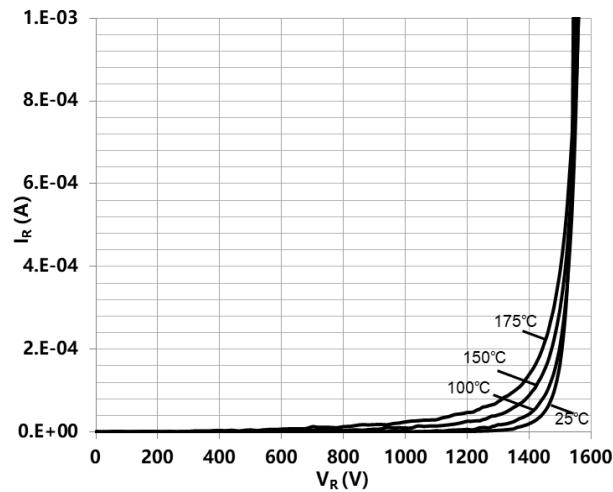


Figure 2. Typical reverse current as function of reverse voltage

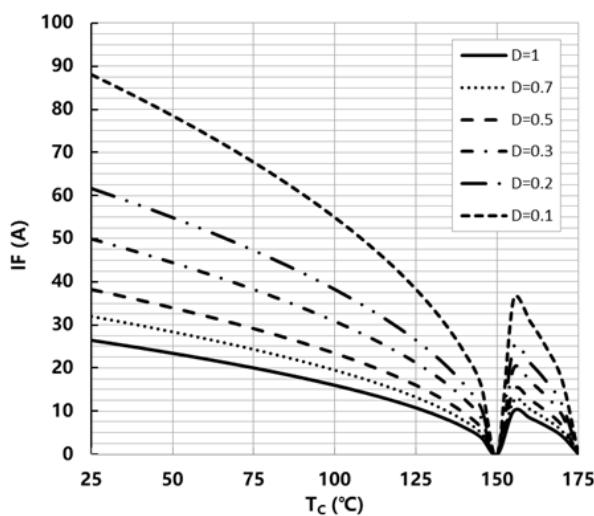


Figure 3. Diode forward current as function of temperature, D=duty cycle

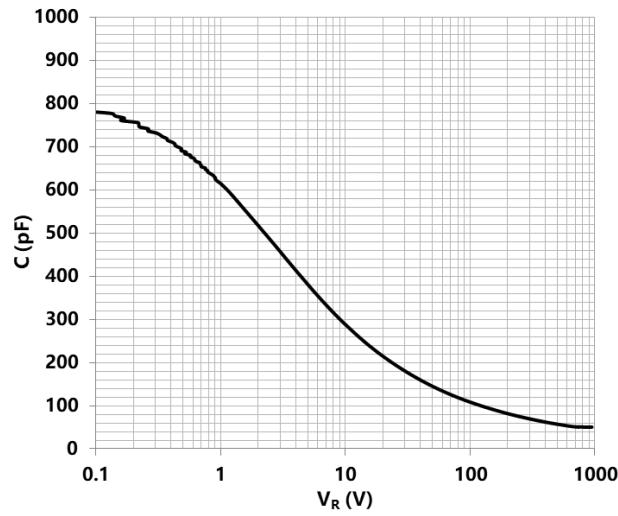


Figure 4. Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_j=25^\circ\text{C}$ ;  $f=1 \text{ MHz}$

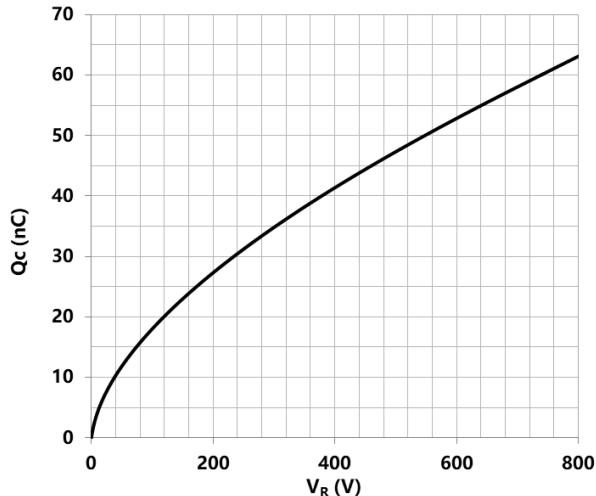


Figure 5. Typical reverse charge as function of reverse voltage

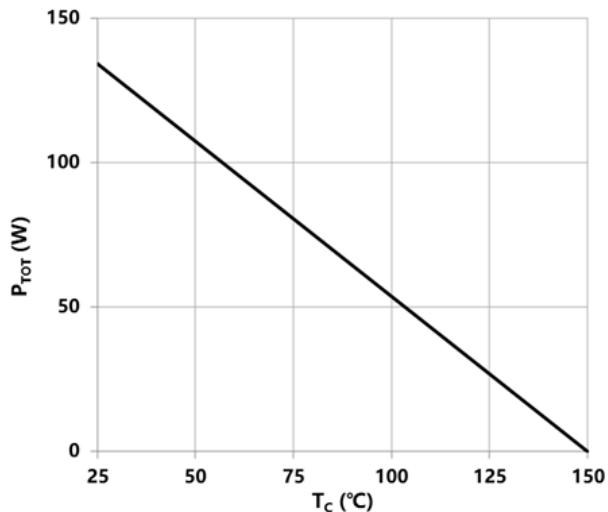


Figure 6. Power dissipation as function of case temperature

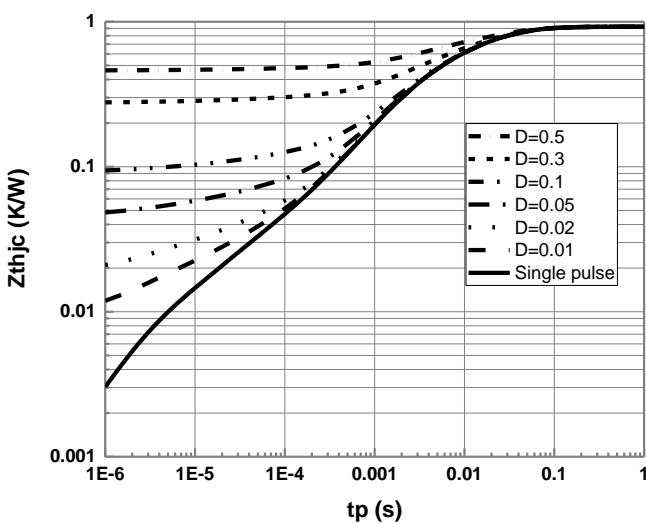
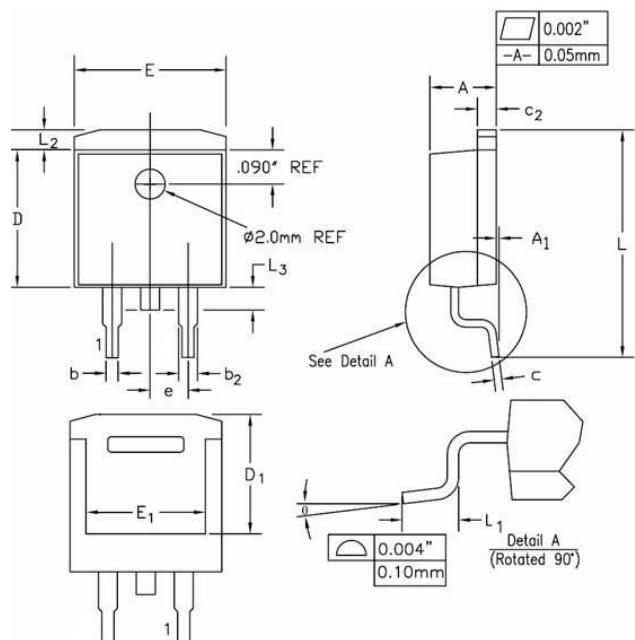


Figure 7. Max. transient thermal impedance,  
 $Z_{th,jc}=f(t_p)$ , parameter:  $D=t_p/T$

## Package Dimensions



POS	Inches		Millimeters	
	Min	Max	Min	Max
A	0.17	0.18	4.32	4.57
A1	-	0.01	-	0.25
b	0.028	0.037	0.71	0.94
b2	0.045	0.055	1.15	1.4
c	0.014	0.025	0.356	0.635
c2	0.048	0.055	1.22	1.4
D	0.35	0.37	8.89	9.4
D1	0.255	0.324	6.48	8.23
E	0.395	0.405	10.04	10.28
E1	0.31	0.318	7.88	8.08
e	0.1	BSC.	2.54	BSC.
L	0.58	0.62	14.73	15.75
L1	0.09	0.11	2.29	2.79
L2	0.045	0.055	1.15	1.39
L3	0.05	0.07	1.27	1.77
θ	0°	8°	0°	8°

## Revision History

**Revision:** Preliminary Version

## Previous Revision

**BASiC Semiconductor Ltd.**  
**Shenzhen, China**  
**© 2018 BASiC Semiconductor Ltd.**  
**All Rights Reserved.**

## Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest BASiC Semiconductor Office

## Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, BASiC semiconductor Ltd. hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

# X-ON Electronics

Largest Supplier of Electrical and Electronic Components

***Click to view similar products for Schottky Diodes & Rectifiers category:***

***Click to view products by BASiC Semiconductor manufacturer:***

Other Similar products are found below :

[CUS06\(TE85L,Q,M\)](#) [MA4E2039](#) [D1FH3-5063](#) [MBR0530L-TP](#) [MBR10100CT-BP](#) [MBR30H100MFST1G](#) [MMBD301M3T5G](#) [PMAD1103-LF](#) [PMAD1108-LF](#) [RB160M-50TR](#) [RB520S-30](#) [RB551V-30](#) [DD350N18K](#) [DZ435N40K](#) [DZ600N16K](#) [BAS16E6433HTMA1](#) [BAS 3010S-02LRH E6327](#) [BAT 54-02LRH E6327](#) [IDL02G65C5XUMA1](#) [NSR05F40QNXT5G](#) [NSVR05F40NXT5G](#) [JANS1N6640](#) [SB07-03C-TB-H](#) [SB1003M3-TL-W](#) [SBAT54CWT1G](#) [SBM30-03-TR-E](#) [SBS818-TL-E](#) [SK32A-LTP](#) [SK33A-TP](#) [SK34A-TP](#) [SK34B-TP](#) [SMD1200PL-TP](#) [ACDBN160-HF](#) [SS3003CH-TL-E](#) [STPS30S45CW](#) [PDS3100Q-7](#) [GA01SHT18](#) [CRS10I30A\(TE85L,QM](#) [MBR1240MFST1G](#) [MBRB30H30CT-1G](#) [BAS28E6433HTMA1](#) [BAS 70-02L E6327](#) [HSB123JTR-E](#) [JANTX1N5712-1](#) [VS-STPS40L45CW-N3](#) [DD350N12K](#) [SB007-03C-TB-E](#) [SB10015M-TL-E](#) [SB1003M3-TL-E](#) [SK110-LTP](#)